



n.jet soldermask

TECHNICAL INFORMATION

INKJET PRINTING OF SOLDER MASK

Replacing subtractive process chains with additive process steps in electronics production has been one of the founding ideas of Notion Systems. It increases production efficiency and reduces waste. On top of this, the n.jet electronics series increase process stability and enables new features in today's electronics production. This pushes the limits of current production technology for rigid and flexible circuitry on any substrate material.

CURRENT PROCESS



INKJET PROCESS



ADVANTAGES ...

- Direct digital print
- Huge cost advantages
 - · Less process steps
 - Less capital costs
 - · Less labor costs
 - Less energy costs
 - Zero waste
- Faster order processing

- New technical possibilities
 - Legendsm
 - Printing of 3D structures
 - Matt & glossy effects
- No mask in holes
- Small and reliable dams
- Adjustable thickness
- No traps for chemical residues

... IN SOLDER MASK PRODUCTION

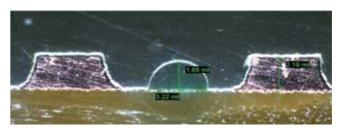
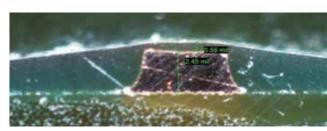
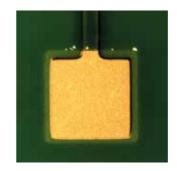


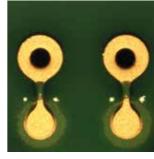
Image shows 3 mil dams: Minimum dam size achievable is < 2 mil (40 microns).



Edge coverage of traces can be adjusted For high copper thickness, only trace edges need additional ink.

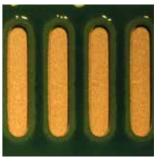


Clear interface area between base meterial, edge and copper.



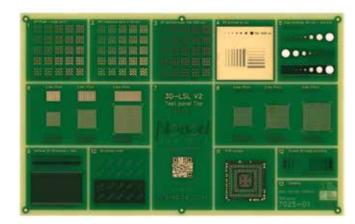
No bleeding

Solder mask edge printing High uniformity No bleeding



Matt & glossy effects Superior edge definition

NOTION SAMPLE BOARD



Fully finished ENIG board

Available for different soldermask inks.

For validation tests such as:

- Adhesion test
- Cross sections
- Scratch tests
- Microscopic views

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Main features

- Digital printing of solder mask & legend
- Manual or fully automated load / unload
- Use of industrial available print heads
- Patented vacuum stage without mechanical clamps
- Integrated non-contact cleaning system
- Highest precision and reliability
- Self maintenance
- Easy to operate
- Automated nozzle calibration

DATA PREPARATION









Panel data .gbr data .odb++ data



Additional data
e. g. Copper thickness
Panel thickness



n.jet cam station
Automatic data preparation
for the inkjet printer
or multiple printers

OPTIONS



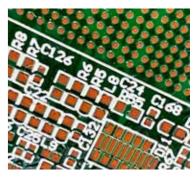
Inline automation. Optical board alignment. Flip function. Adjustable gripper size.



External ink supply.



Legendsm printing with solder mask ink.



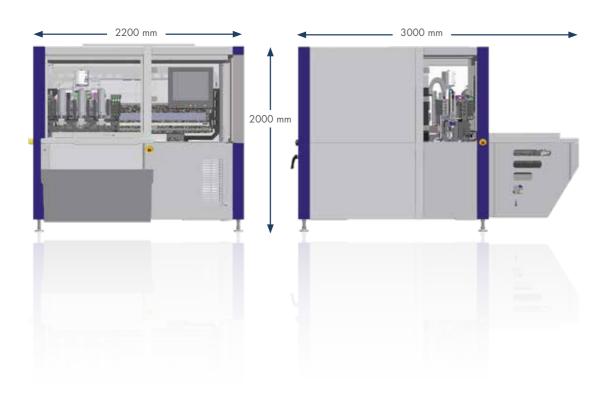
Standard legend

3 Printing









DIMENSIONS & SPECIFICATIONS

• Machine dimensions (WxDxH): 2200mm x 3000mm x 2000mm (87"x118"x79")

• Machine weight: 3500 kg (7720 lbs)

• Max. panel size: 610 x 610mm² (24"x24") larger on request

Up to 9 industrial printheads for soldermask printing In combination with legend printing: 2 for legend & 7 for soldermask • Number of printheads:

• Printing time per side: Depends on copper thickness

Please consult for individual cycle time calculation

Alignment: Optical: 2, 3, 4 fiducials / panel or subpanel

• Load/unload: Manual (standard)

• Automatic load/unload: Yes, optional can be retrofitted after machine installation

• Ink supply: Manual or automatic (option)

• Facility connections: 400V, 16A, 3P, N, PE & CDA 6,5 - 8 bar



NOTION - PROCESS SUPPORT FOR SOLDER MASK & LEGEND PRINTING

Notion's process support team relies on decades of expertise in scaling up functional inkjet processes. We support our customers in the entire inkjet printing process of solder mask and legend printng.

COMERCIALLY AVAILABLE INKS









All inks are UL certified and fulfill IPC-SM-840 E norm.





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THE FUTURE OF ADDITIVE MANUFACTURING







